

COMBINED DECLARATION/POWER OF ATTORNEY FOR UTILITY/DESIGN PATENT APPLICATION

Docket No.: 1793.1181

As a below named inventor, I hereby declare that:

My residence, post office address and clitzenship are as stated below next to my name.

I believe that I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

SOFT DEMODULATION METHOD AND APPARATUS

the specification of which is attached hereto, unless the following box is checked:

was filed on 26 Jan. 2004 as United States Application Number or PCT International Application Number 10/763, 381 and was amended on (if applicable).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any

amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in 37 C.F.R. § 1.56.

I hereby claim foreign priority benefit(a) under 35 U.S.C. § 119(a)-(d) or § 365(a)-(c) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application(s) for patent or inventor's certificate having a filling date before that of the application on which priority is claimed.

Prior Foreign Application	<u>1(8)</u>			Priority NOT
2003-5305	Rep.	of Korea	27 January 2003	<u>Claimed</u> □
(Number)		(Country)	Day/Month/Year Filed	_ ⊔
(Number)		(Country)	Day/Month/Year Flied	_
designating the United States, liste	d below and, in application(s) i ial to patentab	isofar as the subject mat in the manner provided b lity as defined in 37 C.F.	States application(s), or § 365(c) of any PCT inter of each of the claims of this application is no y the first paragraph of 35 U.S.C. § 112, I acknor R. § 1.56 which became available between the floor.	t disclosed in the phor wiedge the duty to
(Application Serial No.)		(Filing Date)	(Status - patented, pending, a	bandoned)
(Application Serial No.)		(Filing Date)	(Status - patented, pending, a	bandoned)
halloyed to be true; and further tha	t these stateme t, or both, unde	ents were made with the l or Section 1001 of Title 18	IIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIII	ike so made are
Full name of sole or first inventor	Sung-h	yu Han		
	of Korea Family 1 of Korea Ki-hyun	danii Apt., M	Date 14 June 2004 Clizenship Rep. of Korea unjung 2-dong, Songpa-gu, Se	eoul,
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Additional inventors are being	named on se	parately numbered she	ets attached hereto.	

UNITED STATES

DOCKETNO.: 1/22	793.1181
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nventor's Signature	Date
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nventor's Signature	Date
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